74AUP1G374

Low-power D-type flip-flop; positive-edge trigger; 3-state

Rev. 5 — 14 July 2010 Product data sheet

1. General description

The 74AUP1G374 provides the single D-type flip-flop with 3-state output. The flip-flop will store the state of data input (D) that meet the set-up and hold times requirements on the LOW-to-HIGH CP transition. When pin \overline{OE} is LOW, the contents of the flip-flop is available at the (Q) output. When pin \overline{OE} is HIGH, the output goes to the high-impedance OFF-state. Operation of input pin \overline{OE} does not affect the state of the flip-flop.

Schmitt trigger action at all inputs makes the circuit tolerant to slower input rise and fall times across the entire V_{CC} range from 0.8 V to 3.6 V. This device ensures a very low static and dynamic power consumption across the entire V_{CC} range from 0.8 V to 3.6 V.

This device is fully specified for partial power-down applications using I_{OFF} . The I_{OFF} circuitry disables the output, preventing the damaging backflow current through the device when it is powered down.

2. Features and benefits

- Wide supply voltage range from 0.8 V to 3.6 V
- High noise immunity
- Complies with JEDEC standards:
 - JESD8-12 (0.8 V to 1.3 V)
 - ◆ JESD8-11 (0.9 V to 1.65 V)
 - ◆ JESD8-7 (1.2 V to 1.95 V)
 - ◆ JESD8-5 (1.8 V to 2.7 V)
 - ◆ JESD8-B (2.7 V to 3.6 V)
- ESD protection:
 - ♦ HBM JESD22-A114F exceeds 5000 V
 - ♦ MM JESD22-A115-A exceeds 200 V
 - CDM JESD22-C101E exceeds 1000 V
- Low static power consumption; $I_{CC} = 0.9 \mu A$ (maximum)
- Latch-up performance exceeds 100 mA per JESD 78 Class II
- Inputs accept voltages up to 3.6 V
- Low noise overshoot and undershoot < 10 % of V_{CC}
- I_{OFF} circuitry provides partial Power-down mode operation
- Multiple package options
- Specified from -40 °C to +85 °C and -40 °C to +125 °C



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3. Ordering information

Table 1. Ordering information

Type number	Package									
	Temperature range	Name	Description	Version						
74AUP1G374GW	–40 °C to +125 °C	SC-88	plastic surface-mounted package; 6 leads	SOT363						
74AUP1G374GM	–40 °C to +125 °C	XSON6	plastic extremely thin small outline package; no leads; 6 terminals; body 1 \times 1.45 \times 0.5 mm	SOT886						
74AUP1G374GF	–40 °C to +125 °C	XSON6	plastic extremely thin small outline package; no leads; 6 terminals; body 1 \times 1 \times 0.5 mm	SOT891						
74AUP1G374GN	–40 °C to +125 °C	XSON6	extremely thin small outline package; no leads; 6 terminals; body $0.9 \times 1.0 \times 0.35$ mm	SOT1115						
74AUP1G374GS	–40 °C to +125 °C	XSON6	extremely thin small outline package; no leads; 6 terminals; body 1.0 \times 1.0 \times 0.35 mm	SOT1202						

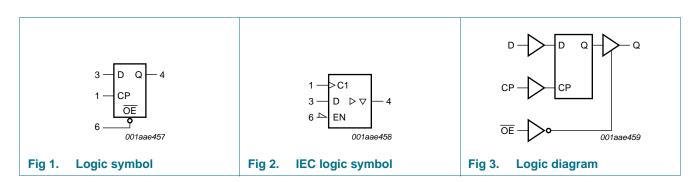
4. Marking

Table 2. Marking

Type number	Marking code ^[1]
74AUP1G374GW	aX
74AUP1G374GM	aX
74AUP1G374GF	aX
74AUP1G374GN	aX
74AUP1G374GS	aX

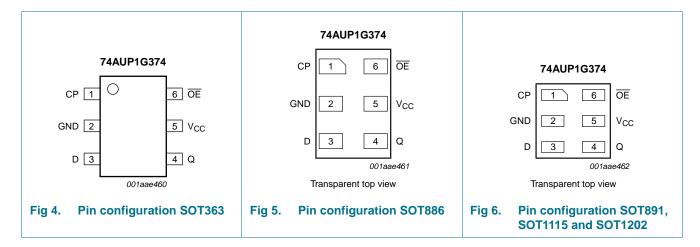
^[1] The pin 1 indicator is located on the lower left corner of the device, below the marking code.

5. Functional diagram



6. Pinning information

6.1 Pinning



6.2 Pin description

Table 3. Pin description

Symbol	Pin	Description
CP	1	clock input (LOW-to-HIGH, edge-triggered)
GND	2	ground (0 V)
D	3	data input
Q	4	3-state flip-flop output
V _{CC}	5	supply voltage
ŌE	6	output enable input (active LOW)

7. Functional description

Table 4. Function table[1]

Operating mode	Input		Internal	Output	
	OE	СР	D	flip-flop	Q
Load and read register	L	↑	I	L	L
	L	↑	h	Н	Н
Load register and disable output	Н	↑	I	L	Z
	Н	↑	h	Н	Z

^[1] H = HIGH voltage level;

h = HIGH voltage level one set-up time prior to the HIGH-to-LOW LE transition;

 $\label{eq:lower} I = LOW \ voltage \ level \ one \ set-up \ time \ prior \ to \ the \ HIGH-to-LOW \ LE \ transition;$

L = LOW voltage level;

Z = high-impedance OFF-state;

 $[\]uparrow$ = LOW-to-HIGH clock transition.

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8. Limiting values

Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	Min	Max	Unit
V_{CC}	supply voltage		-0.5	+4.6	V
I _{IK}	input clamping current	V _I < 0 V	-50	-	mA
VI	input voltage		<u>[1]</u> –0.5	+4.6	V
I _{OK}	output clamping current	V _O < 0 V	-50	-	mA
Vo	output voltage	Active mode and Power-down mode	<u>[1]</u> –0.5	+4.6	V
Io	output current	$V_O = 0 V \text{ to } V_{CC}$	-	±20	mA
I _{CC}	supply current		-	50	mA
I_{GND}	ground current		-50	-	mA
T _{stg}	storage temperature		-65	+150	°C
P _{tot}	total power dissipation	$T_{amb} = -40 ^{\circ}\text{C} \text{ to } +125 ^{\circ}\text{C}$	[2] -	250	mW

^[1] The minimum input and output voltage ratings may be exceeded if the input and output current ratings are observed.

9. Recommended operating conditions

Table 6. Recommended operating conditions

Symbol	Parameter	Conditions	Min	Max	Unit
V_{CC}	supply voltage		0.8	3.6	V
VI	input voltage		0	3.6	V
Vo	output voltage	Active mode	0	V_{CC}	V
		Power-down mode; V _{CC} = 0 V	0	3.6	V
T _{amb}	ambient temperature		-40	+125	°C
$\Delta t/\Delta V$	input transition rise and fall rate	V _{CC} = 0.8 V to 3.6 V	0	200	ns/V

^[2] For SC-88 packages: above 87.5 °C the value of P_{tot} derates linearly with 4.0 mW/K. For XSON6 package: above 118 °C the value of P_{tot} derates linearly with 7.8 mW/K.

10. Static characteristics

Table 7. Static characteristics

At recommended operating conditions; voltages are referenced to GND (ground = 0 V).

_	Parameter	Conditions	Min	Тур	Max	Unit
T _{amb} = 2						
V_{IH}	HIGH-level input voltage	V _{CC} = 0.8 V	$0.70 \times V_{CC}$		-	V
		V _{CC} = 0.9 V to 1.95 V	$0.65 \times V_{CC}$	-	-	V
		$V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$	1.6	-	-	V
		$V_{CC} = 3.0 \text{ V to } 3.6 \text{ V}$	2.0	-	-	V
V_{IL}	LOW-level input voltage	$V_{CC} = 0.8 \text{ V}$	-	-		V
		$V_{CC} = 0.9 \text{ V to } 1.95 \text{ V}$	-	-	$0.35 \times V_{CC}$	V
		$V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$	-	-	0.7	V
		$V_{CC} = 3.0 \text{ V to } 3.6 \text{ V}$	-	-	0.9	V
V_{OH}	HIGH-level output voltage	$V_I = V_{IH}$ or V_{IL}				
		$I_O = -20 \mu A$; $V_{CC} = 0.8 \text{ V}$ to 3.6 V	$V_{CC}-0.1$	-	-	V
		$I_O = -1.1 \text{ mA}; V_{CC} = 1.1 \text{ V}$	$0.75 \times V_{CC}$	-	-	V
		$I_O = -1.7 \text{ mA}; V_{CC} = 1.4 \text{ V}$	1.11	-	-	V
		$I_O = -1.9 \text{ mA}; V_{CC} = 1.65 \text{ V}$	1.32	-	-	V
		$I_O = -2.3 \text{ mA}$; $V_{CC} = 2.3 \text{ V}$	2.05	-	-	V
		$I_O = -3.1 \text{ mA}$; $V_{CC} = 2.3 \text{ V}$	1.9	-	-	V
	$I_0 = -2.7 \text{ mA}; V_{CC} = 3.0 \text{ V}$ 2.72	-	-	V		
		$I_O = -4.0 \text{ mA}$; $V_{CC} = 3.0 \text{ V}$	2.6	-	-	V
V_{OL}	LOW-level output voltage	$V_I = V_{IH}$ or V_{IL}				
		$I_O = 20 \mu A$; $V_{CC} = 0.8 \text{ V to } 3.6 \text{ V}$	-	-	0.1	V
		$I_O = 1.1 \text{ mA}; V_{CC} = 1.1 \text{ V}$	-	-	$0.3 \times V_{CC}$	V
		$I_O = 1.7 \text{ mA}; V_{CC} = 1.4 \text{ V}$	-	-	0.31	V
		$I_O = 1.9 \text{ mA}; V_{CC} = 1.65 \text{ V}$	-	-	0.35 × V _{CC} 0.7 0.9 0.1 0.3 × V _{CC} 0.31 0.31 0.31 0.44 0.31 0.44 ±0.1	V
		$I_{O} = 2.3 \text{ mA}; V_{CC} = 2.3 \text{ V}$	-	-		V
		$I_O = 3.1 \text{ mA}; V_{CC} = 2.3 \text{ V}$	-	-		V
		$I_O = 2.7 \text{ mA}; V_{CC} = 3.0 \text{ V}$	-	-	0.31	V
		$I_{O} = 4.0 \text{ mA}; V_{CC} = 3.0 \text{ V}$	-	-	0.44	V
I _I	input leakage current	$V_I = GND$ to 3.6 V; $V_{CC} = 0$ V to 3.6 V	-	-	±0.1	μΑ
l _{OZ}	OFF-state output current	$V_I = V_{IH}$ or V_{IL} ; $V_O = 0$ V to 3.6 V; $V_{CC} = 0$ V to 3.6 V	-	-	±0.1	μΑ
I _{OFF}	power-off leakage current	V_I or $V_O = 0$ V to 3.6 V; $V_{CC} = 0$ V	-	-	±0.2	μΑ
ΔI_{OFF}	additional power-off leakage current	V_1 or $V_0 = 0$ V to 3.6 V; $V_{CC} = 0$ V to 0.2 V	-	-	±0.2	μΑ
I _{CC}	supply current	$V_{I} = GND \text{ or } V_{CC}; I_{O} = 0 \text{ A};$ $V_{CC} = 0.8 \text{ V to } 3.6 \text{ V}$	-	-	0.5	μΑ
Δl _{CC}	additional supply current	$V_I = V_{CC} - 0.6 \text{ V}; I_O = 0 \text{ A};$ $V_{CC} = 3.3 \text{ V}$	[1] -	-	40	μΑ
Cı	input capacitance	$V_{CC} = 0 \text{ V to } 3.6 \text{ V; } V_I = \text{GND or } V_{CC}$	-	8.0	-	pF

 Table 7.
 Static characteristics ...continued

At recommended operating conditions; voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	Min	Тур	Max	Uni
Co	output capacitance	output enabled; $V_O = GND$; $V_{CC} = 0 V$	-	1.7	-	pF
		output disabled; $V_{CC} = 0 \text{ V to } 3.6 \text{ V};$ $V_O = \text{GND or } V_{CC}$	GND; $V_{CC} = 0 \text{ V}$ - 1.7 - pl = 0 V to 3.6 V; - 1.5 - pl = 0.70 × V_{CC} V 0.65 × V_{CC} V 1.6 - V 2.0 V 2.0 0.35 × V_{CC} V - 0.35 × V_{CC} V - 0.35 × V_{CC} V - 0.9 V 0.8 V to 3.6 V V_{CC} V 1.03 V 1.03 V 1.05 V	pF		
Γ _{amb} = -	40 °C to +85 °C					
/ _{IH}	HIGH-level input voltage	V _{CC} = 0.8 V	$0.70 \times V_{CC}$	-	-	V
		V _{CC} = 0.9 V to 1.95 V	$0.65 \times V_{CC}$	-	-	V
		V _{CC} = 2.3 V to 2.7 V	1.6	-	-	V
		V _{CC} = 3.0 V to 3.6 V	2.0	-	-	V
/ _{IL}	LOW-level input voltage	V _{CC} = 0.8 V	-	-	$0.30 \times V_{CC}$	V
		V _{CC} = 0.9 V to 1.95 V	-	-	$0.35 \times V_{CC}$	V
		V _{CC} = 2.3 V to 2.7 V	-	-	0.7	V
		V _{CC} = 3.0 V to 3.6 V	-	-	0.9	V
√ _{OH}	HIGH-level output voltage	$V_I = V_{IH}$ or V_{IL}				
		$I_O = -20 \mu A$; $V_{CC} = 0.8 \text{ V}$ to 3.6 V	V _{CC} - 0.1	-	-	V
		$I_{O} = -1.1 \text{ mA}; V_{CC} = 1.1 \text{ V}$	$0.7 \times V_{CC}$	-	-	V
		$I_{O} = -1.7 \text{ mA}; V_{CC} = 1.4 \text{ V}$	1.03	-	-	V
		$I_{O} = -1.9 \text{ mA}; V_{CC} = 1.65 \text{ V}$	1.30	-	-	V
		$I_{O} = -2.3 \text{ mA}; V_{CC} = 2.3 \text{ V}$	1.97	-	-	٧
		$I_{O} = -3.1 \text{ mA}; V_{CC} = 2.3 \text{ V}$	1.85	-	-	٧
		$I_{O} = -2.7 \text{ mA}; V_{CC} = 3.0 \text{ V}$	2.67	-	-	٧
		$I_{O} = -4.0 \text{ mA}; V_{CC} = 3.0 \text{ V}$	2.55	-	-	V
/ _{OL}	LOW-level output voltage	$V_I = V_{IH}$ or V_{IL}				
		$I_O = 20 \mu A$; $V_{CC} = 0.8 \text{ V to } 3.6 \text{ V}$	-	-	0.1	V
		I _O = 1.1 mA; V _{CC} = 1.1 V	-	-	$0.3 \times V_{CC}$	V
OH F		I _O = 1.7 mA; V _{CC} = 1.4 V	-	-	0.37	V
		$I_O = 1.9 \text{ mA}; V_{CC} = 1.65 \text{ V}$	-	-	0.35	V
		$I_O = 2.3 \text{ mA}; V_{CC} = 2.3 \text{ V}$	-	-	0.33	V
		$I_O = 3.1 \text{ mA}; V_{CC} = 2.3 \text{ V}$	-	-	0.45	V
		$I_O = 2.7 \text{ mA}; V_{CC} = 3.0 \text{ V}$	-	-	0.33	V
		$I_O = 4.0 \text{ mA}; V_{CC} = 3.0 \text{ V}$	0.9 V to 3.6 V	0.45	V	
I	input leakage current	$V_{I} = GND \text{ to } 3.6 \text{ V}; V_{CC} = 0 \text{ V to } 3.6 \text{ V}$	-	-	±0.5	μΑ
OZ	OFF-state output current	$V_I = V_{IH} \text{ or } V_{IL}; V_O = 0 \text{ V to } 3.6 \text{ V}; V_{CC} = 0 \text{ V to } 3.6 \text{ V}$	-	-	±0.5	μΑ
OFF	power-off leakage current	V_{I} or $V_{O} = 0 \text{ V to } 3.6 \text{ V; } V_{CC} = 0 \text{ V}$	-	-	±0.5	μΑ
N _{OFF}	additional power-off leakage current	V_1 or $V_0 = 0$ V to 3.6 V; $V_{CC} = 0$ V to 0.2 V	-	-	±0.6	μΑ
CC	supply current	V_I = GND or V_{CC} ; I_O = 0 A; V_{CC} = 0.8 V to 3.6 V	-	-	0.9	μΑ
VI _{CC}	additional supply current	$V_{I} = V_{CC} - 0.6 \text{ V}; I_{O} = 0 \text{ A};$ $V_{CC} = 3.3 \text{ V}$	[1] -	-	50	μΑ

 Table 7.
 Static characteristics ...continued

At recommended operating conditions; voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
T _{amb} = -	40 °C to +125 °C					
V _{IH}	HIGH-level input voltage	V _{CC} = 0.8 V	$0.75 \times V_{CC}$	-	-	V
		V _{CC} = 0.9 V to 1.95 V	$0.70 \times V_{CC}$	-	-	V
		V _{CC} = 2.3 V to 2.7 V	1.6	-	-	V
		$V_{CC} = 3.0 \text{ V to } 3.6 \text{ V}$	2.0	-	-	V
V _{IL}	LOW-level input voltage	V _{CC} = 0.8 V	-	-	$0.25 \times V_{CC}$	V
		V _{CC} = 0.9 V to 1.95 V	-	-	$0.30 \times V_{CC}$	V
		$V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$	-	-	0.7	٧
		$V_{CC} = 3.0 \text{ V to } 3.6 \text{ V}$	-	-	0.9	٧
V _{OH}	HIGH-level output voltage	$V_I = V_{IH}$ or V_{IL}				
		$I_{O} = -20 \mu A$; $V_{CC} = 0.8 \text{ V to } 3.6 \text{ V}$	V _{CC} - 0.11	-	-	V
		$I_{O} = -1.1 \text{ mA}; V_{CC} = 1.1 \text{ V}$	$0.6 \times V_{CC}$	-	-	٧
		$I_{O} = -1.7 \text{ mA}; V_{CC} = 1.4 \text{ V}$	0.93	-	-	V
		$I_{O} = -1.9 \text{ mA}; V_{CC} = 1.65 \text{ V}$	1.17	-	-	V
		$I_{O} = -2.3 \text{ mA}; V_{CC} = 2.3 \text{ V}$	1.77	-	-	V
		$I_{O} = -3.1 \text{ mA}; V_{CC} = 2.3 \text{ V}$	1.67	-	-	V
		$I_{O} = -2.7 \text{ mA}; V_{CC} = 3.0 \text{ V}$	2.40	-	-	V
		$I_{O} = -4.0 \text{ mA}; V_{CC} = 3.0 \text{ V}$	2.30		V	
√ _{OL}	LOW-level output voltage	$V_I = V_{IH}$ or V_{IL}				
		$I_O = 20 \mu A$; $V_{CC} = 0.8 \text{ V to } 3.6 \text{ V}$	$V_{CC} = 0.8 \text{ V to } 3.6 \text{ V}$ 0.11	V		
		I _O = 1.1 mA; V _{CC} = 1.1 V	-	-	$0.33 \times V_{CC}$	٧
		$I_O = 1.7 \text{ mA}; V_{CC} = 1.4 \text{ V}$	-	-		٧
		$I_O = 1.9 \text{ mA}; V_{CC} = 1.65 \text{ V}$	-	0.70 × V _{CC}	٧	
		$ \begin{array}{cccccccccccccccccccccccccccccccccccc$	0.36	V		
		$I_{O} = 3.1 \text{ mA}; V_{CC} = 2.3 \text{ V}$	-	-	0.30 × V _{CC} 0.7 0.9	V
		$I_O = 2.7 \text{ mA}; V_{CC} = 3.0 \text{ V}$	-	-	0.36	V
		$I_O = 4.0 \text{ mA}; V_{CC} = 3.0 \text{ V}$	-	-	0.50	٧
I	input leakage current	$V_I = GND$ to 3.6 V; $V_{CC} = 0$ V to 3.6 V	-	-	±0.75	μΑ
OZ	OFF-state output current	$V_I = V_{IH}$ or V_{IL} ; $V_O = 0$ V to 3.6 V; $V_{CC} = 0$ V to 3.6 V	-	-	±0.75	μΑ
OFF	power-off leakage current	V_I or $V_O = 0$ V to 3.6 V; $V_{CC} = 0$ V	-	-	±0.75	μΑ
√l _{OFF}	additional power-off leakage current	V_1 or $V_0 = 0$ V to 3.6 V; $V_{CC} = 0$ V to 0.2 V	-	-	±0.75	μΑ
СС	supply current	$V_{I} = GND \text{ or } V_{CC}; I_{O} = 0 \text{ A};$ $V_{CC} = 0.8 \text{ V to } 3.6 \text{ V}$	-	-	1.4	μΑ
∆l _{CC}	additional supply current	$V_{I} = V_{CC} - 0.6 \text{ V}; I_{O} = 0 \text{ A};$ $V_{CC} = 3.3 \text{ V}$	<u>[1]</u> -	-	75	μΑ

^[1] One input at V_{CC} – 0.6 V, other input at V_{CC} or GND.

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11. Dynamic characteristics

Table 8. Dynamic characteristics

Voltages are referenced to GND (ground = 0 V); for test circuit see Figure 9.

Symbol	Parameter	Conditions			25 °C			-40 °C	to +125 °C	;	Unit
				Min	Typ[1]	Max	Min (85 °C)	Max (85 °C)	Min (125 °C)	Max (125 °C)	
$C_L = 5 p$	F							1			
t _{pd}		CP to Q; see Figure 7	[2]								
	delay	$V_{CC} = 0.8 \text{ V}$		-	23.6	-	-	-	-	-	ns
		$V_{CC} = 1.1 \text{ V to } 1.3 \text{ V}$		2.4	6.3	13.1	2.3	13.3	2.3	13.4	ns
		$V_{CC} = 1.4 \text{ V to } 1.6 \text{ V}$		2.1	4.3	7.4	1.8	8.0	1.8	8.2	ns
		$V_{CC} = 1.65 \text{ V to } 1.95 \text{ V}$		1.6	3.4	5.8	1.4	6.4	1.4	6.7	ns
		$V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$		1.4	2.5	3.8	1.1	4.3	1.1	4.5	ns
		$V_{CC} = 3.0 \text{ V to } 3.6 \text{ V}$		1.2	2.1	3.0	1.0	3.4	1.0	3.6	ns
t _{en}	enable time	OE to Q; see Figure 8	[3]								
		$V_{CC} = 0.8 \text{ V}$		-	21.7	-	-	-	-	-	ns
		$V_{CC} = 1.1 \text{ V to } 1.3 \text{ V}$		3.3	5.2	8.1	3.0	9.1	3.0	10.0	ns
		$V_{CC} = 1.4 \text{ V to } 1.6 \text{ V}$		2.6	4.1	5.6	2.4	6.1	2.4	6.7	ns
		$V_{CC} = 1.65 \text{ V to } 1.95 \text{ V}$		2.3	3.4	4.6	2.0	5.1	2.0	5.6	ns
		$V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$		2.0	2.8	3.7	1.8	4.0	1.8	4.4	ns
		$V_{CC} = 3.0 \text{ V to } 3.6 \text{ V}$		1.9	2.6	3.4	1.8	3.5	1.8	3.9	ns
t _{dis}	disable time	OE to Q; see Figure 8	[4]								
		$V_{CC} = 0.8 \text{ V}$		-	9.8	-	-	-	-	-	ns
		$V_{CC} = 1.1 \text{ V to } 1.3 \text{ V}$		2.9	4.5	7.0	2.8	7.2	2.8	7.9	ns
		$V_{CC} = 1.4 \text{ V to } 1.6 \text{ V}$		2.3	3.3	4.9	2.1	5.1	2.1	5.6	ns
		$V_{CC} = 1.65 \text{ V to } 1.95 \text{ V}$		2.2	3.2	4.5	2.1	4.7	2.1	5.2	ns
		$V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$		1.6	2.3	3.1	1.5	3.4	1.5	3.7	ns
		$V_{CC} = 3.0 \text{ V to } 3.6 \text{ V}$		1.9	2.6	3.4	1.8	3.6	1.8	4.0	ns
f _{max}	maximum	CP; see Figure 7									
	frequency	V _{CC} = 0.8 V		-	53	-	-	-	-	-	MHz
		V _{CC} = 1.1 V to 1.3 V		-	203	-	170	-	170	-	MHz
		V _{CC} = 1.4 V to 1.6 V		-	347	-	310	-	300	-	MHz
		V _{CC} = 1.65 V to 1.95 V		-	435	-	400	-	390	-	MHz
		$V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$		-	550	-	490	-	480	-	MHz
		$V_{CC} = 3.0 \text{ V to } 3.6 \text{ V}$		-	619	-	550	-	510	-	MHz

Table 8. Dynamic characteristics ...continued

Voltages are referenced to GND (ground = 0 V); for test circuit see <u>Figure 9</u>.

Symbol	Parameter	Conditions			25 °C			-40 °C	to +125 °C	;	Unit
				Min	Typ[1]	Max	Min (85 °C)	Max (85 °C)	Min (125 °C)	Max (125 °C)	
C _L = 10	pF										
t _{pd}	propagation	CP to Q; see Figure 7	[2]								
	delay	V _{CC} = 0.8 V		-	27.1	-	-	-	-	-	ns
		$V_{CC} = 1.1 \text{ V to } 1.3 \text{ V}$		2.7	7.2	14.7	2.5	15.0	2.5	15.1	ns
		$V_{CC} = 1.4 \text{ V to } 1.6 \text{ V}$		2.3	4.9	8.6	2.0	9.1	2.0	9.4	ns
		$V_{CC} = 1.65 \text{ V to } 1.95 \text{ V}$		2.1	4.0	6.5	1.9	7.0	1.9	7.3	ns
		$V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$		1.8	3.1	4.4	1.5	4.9	1.5	5.1	ns
		$V_{CC} = 3.0 \text{ V to } 3.6 \text{ V}$		1.6	2.7	3.7	1.3	4.0	1.3	4.2	ns
t _{en}	enable time	OE to Q; see Figure 8	[3]								
		$V_{CC} = 0.8 \text{ V}$		-	25.1	-	-	-	-	-	ns
		$V_{CC} = 1.1 \text{ V to } 1.3 \text{ V}$		3.8	6.5	10.2	3.5	10.6	3.5	11.7	ns
		$V_{CC} = 1.4 \text{ V to } 1.6 \text{ V}$		3.1	4.7	6.5	2.7	7.1	2.7	7.8	ns
		$V_{CC} = 1.65 \text{ V to } 1.95 \text{ V}$		2.7	4.0	5.4	2.5	6.0	2.5	6.6	ns
		$V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$		2.4	3.4	4.5	2.2	4.7	2.2	5.2	ns
		$V_{CC} = 3.0 \text{ V to } 3.6 \text{ V}$		2.3	3.1	4.1	2.1	4.2	2.1	4.6	ns
t _{dis} di	disable time	OE to Q; see Figure 8	[4]								
		$V_{CC} = 0.8 \text{ V}$		-	11.7	-	-	-	-	-	ns
		V _{CC} = 1.1 V to 1.3 V		3.9	5.6	8.3	3.9	8.4	3.9	9.2	ns
		$V_{CC} = 1.4 \text{ V to } 1.6 \text{ V}$		3.1	4.2	5.8	3.0	6.1	3.0	6.7	ns
		$V_{CC} = 1.65 \text{ V to } 1.95 \text{ V}$		3.2	4.3	5.7	3.1	5.9	3.1	6.5	ns
		$V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$		2.3	3.1	4.0	2.2	4.2	2.2	4.6	ns
		$V_{CC} = 3.0 \text{ V to } 3.6 \text{ V}$		3.0	3.8	4.8	2.9	5.0	2.9	5.5	ns
f _{max}	maximum	CP; see Figure 7									
	frequency	$V_{CC} = 0.8 \text{ V}$		-	52	-	-	-	-	-	MHz
		$V_{CC} = 1.1 \text{ V to } 1.3 \text{ V}$		-	192	-	150	-	150	-	MHz
		$V_{CC} = 1.4 \text{ V to } 1.6 \text{ V}$		-	324	-	280	-	230	-	MHz
		$V_{CC} = 1.65 \text{ V to } 1.95 \text{ V}$		-	421	-	310	-	250	-	MHz
		$V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$		-	486	-	370	-	360	-	MHz
		$V_{CC} = 3.0 \text{ V to } 3.6 \text{ V}$		-	550	-	410	-	360	-	MHz
C _L = 15	pF										
t _{pd}	propagation	CP to Q; see Figure 7	[2]								
	delay	$V_{CC} = 0.8 \text{ V}$		-	30.6	-	-	-	-	-	ns
		V _{CC} = 1.1 V to 1.3 V		3.0	8.0	16.2	2.8	16.5	2.8	16.6	ns
		V _{CC} = 1.4 V to 1.6 V		2.8	5.5	9.3	2.4	10.1	2.4	10.4	ns
		V _{CC} = 1.65 V to 1.95 V		2.3	4.5	7.2	2.1	7.9	2.1	8.2	ns
		V _{CC} = 2.3 V to 2.7 V		2.1	3.5	5.0	1.9	5.5	1.9	5.7	ns
		$V_{CC} = 3.0 \text{ V to } 3.6 \text{ V}$		2.0	3.1	4.3	1.7	4.7	1.7	5.0	ns

Table 8. Dynamic characteristics ...continued

Voltages are referenced to GND (ground = 0 V); for test circuit see <u>Figure 9</u>.

Symbol	Parameter	Conditions			25 °C			-40 °C	to +125 °C	;	Unit
				Min	Typ[1]	Max	Min (85 °C)	Max (85 °C)	Min (125 °C)	Max (125 °C)	
t _{en}	enable time	OE to Q; see Figure 8	[3]		'	•	•	'			
		$V_{CC} = 0.8 \text{ V}$		-	28.6	-	-	-	-	-	ns
		$V_{CC} = 1.1 \text{ V to } 1.3 \text{ V}$		4.3	7.4	11.6	3.9	12.1	3.9	13.3	ns
		$V_{CC} = 1.4 \text{ V to } 1.6 \text{ V}$		3.5	5.3	7.2	3.1	8.0	3.1	8.8	ns
		V_{CC} = 1.65 V to 1.95 V		3.1	4.5	6.1	2.8	6.7	2.8	7.4	ns
		$V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$		2.7	3.8	5.0	2.5	5.4	2.5	5.9	ns
		$V_{CC} = 3.0 \text{ V to } 3.6 \text{ V}$		2.7	3.6	4.7	2.5	4.9	2.5	5.4	ns
dis	disable time	OE to Q; see Figure 8	[4]								
		V _{CC} = 0.8 V		-	13.5	-	-	-	-	-	ns
		$V_{CC} = 1.1 \text{ V to } 1.3 \text{ V}$		5.0	6.8	9.5	4.9	9.6	4.9	10.6	ns
		$V_{CC} = 1.4 \text{ V to } 1.6 \text{ V}$		3.9	5.1	6.8	3.8	7.0	3.8	7.7	ns
		V_{CC} = 1.65 V to 1.95 V		4.3	5.4	7.0	4.1	7.2	4.1	7.9	ns
		$V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$		3.0	3.9	4.9	2.9	5.1	2.9	5.6	ns
		$V_{CC} = 3.0 \text{ V to } 3.6 \text{ V}$		4.1	5.1	6.2	4.0	6.4	4.0	7.0	ns
max	maximum	CP; see Figure 7									
	frequency	V _{CC} = 0.8 V		-	50	-	-	-	-	-	MHz
		$V_{CC} = 1.1 \text{ V to } 1.3 \text{ V}$		-	181	-	120	-	120	-	MHz
		$V_{CC} = 1.4 \text{ V to } 1.6 \text{ V}$		-	301	-	190	-	160	-	MHz
		$V_{CC} = 1.65 \text{ V to } 1.95 \text{ V}$		-	407	-	240	-	190	-	MHz
		$V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$		-	422	-	300	-	270	-	MHz
		$V_{CC} = 3.0 \text{ V to } 3.6 \text{ V}$		-	481	-	320	-	300	-	MHz
C _L = 30	pF										
pd	propagation	CP to Q; see Figure 7	[2]								
	delay	V _{CC} = 0.8 V		-	40.8	-	-	-	-	-	ns
		$V_{CC} = 1.1 \text{ V to } 1.3 \text{ V}$		3.7	10.3	20.5	3.5	21.2	3.5	21.6	ns
		$V_{CC} = 1.4 \text{ V to } 1.6 \text{ V}$		3.3	7.0	11.6	3.2	12.6	3.2	13.3	ns
		$V_{CC} = 1.65 \text{ V to } 1.95 \text{ V}$		3.2	5.8	9.1	2.9	9.8	2.9	10.4	ns
		$V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$		3.0	4.7	6.5	2.6	7.0	2.6	7.4	ns
		$V_{CC} = 3.0 \text{ V to } 3.6 \text{ V}$		2.9	4.2	5.8	2.5	6.6	2.5	6.9	ns
en	enable time	OE to Q; see Figure 8	[3]								
		V _{CC} = 0.8 V		-	39.0	-	-	-	-	-	ns
		V _{CC} = 1.1 V to 1.3 V		5.6	9.8	15.7	5.0	16.5	5.0	18.2	ns
		$V_{CC} = 1.4 \text{ V to } 1.6 \text{ V}$		4.6	7.0	9.5	4.1	10.6	4.1	11.7	ns
		V _{CC} = 1.65 V to 1.95 V		4.1	5.9	7.9	3.7	8.6	3.7	9.5	ns
		V _{CC} = 2.3 V to 2.7 V		3.7	5.0	6.6	3.3	7.1	3.3	7.8	ns
		V _{CC} = 3.0 V to 3.6 V		3.5	4.8	6.2	3.2	6.5	3.2	7.2	ns

Table 8. Dynamic characteristics ...continued Voltages are referenced to GND (ground = 0 V); for test circuit see <u>Figure 9</u>.

Symbol	Parameter	Conditions		25 °C		-40 °C to +125 °C				Unit
			Min	Typ[1]	Max	Min (85 °C)	Max (85 °C)	Min (125 °C)	Max (125 °C)	
t _{dis}	disable time	OE to Q; see Figure 8	<u>[4]</u>	1						1
		V _{CC} = 0.8 V	-	19.0	-	-	-	-	-	ns
		$V_{CC} = 1.1 \text{ V to } 1.3 \text{ V}$	8.1	10.2	13.3	8.0	13.5	8.0	14.9	ns
		$V_{CC} = 1.4 \text{ V to } 1.6 \text{ V}$	6.4	7.8	9.7	6.3	10.0	6.3	11.0	ns
		V_{CC} = 1.65 V to 1.95 V	7.4	8.8	10.7	7.2	10.9	7.2	12.0	ns
		$V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$	5.2	6.3	7.5	5.1	7.8	5.1	8.6	ns
		$V_{CC} = 3.0 \text{ V to } 3.6 \text{ V}$	7.5	8.8	10.3	7.4	10.5	7.4	11.6	ns
f _{max}	maximum	CP; see Figure 7								
	frequency	$V_{CC} = 0.8 \text{ V}$	-	28	-	-	-	-	-	MHz
		$V_{CC} = 1.1 \text{ V to } 1.3 \text{ V}$	-	128	-	70	-	70	-	MHz
		V _{CC} = 1.4 V to 1.6 V	-	206	-	120	-	110	-	MHz
		$V_{CC} = 1.65 \text{ V to } 1.95 \text{ V}$	-	262	-	150	-	120	-	MHz
		$V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$	-	269	-	190	-	170	-	MHz
		$V_{CC} = 3.0 \text{ V to } 3.6 \text{ V}$	-	309	-	200	-	190	-	MHz
$C_L = 5 p$	F, 10 pF, 15 p	F and 30 pF								
t _W	pulse width	CP; HIGH or LOW; see Figure 7								
		$V_{CC} = 0.8 \text{ V}$	-	5.1	-	-	-	-	-	ns
		$V_{CC} = 1.1 \text{ V to } 1.3 \text{ V}$	-	1.5	-	3.2	-	3.5	-	ns
		$V_{CC} = 1.4 \text{ V to } 1.6 \text{ V}$	-	0.9	-	1.5	-	1.7	-	ns
		$V_{CC} = 1.65 \text{ V to } 1.95 \text{ V}$	-	0.7	-	1.0	-	1.1	-	ns
		$V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$	-	0.5	-	0.8	-	0.8	-	ns
		$V_{CC} = 3.0 \text{ V to } 3.6 \text{ V}$	-	0.5	-	0.7	-	0.8	-	ns
t _{su(H)}	set-up time	D to CP; see Figure 7								
	HIGH	$V_{CC} = 0.8 \text{ V}$	-	2.1	-	-	-	-	-	ns
		$V_{CC} = 1.1 \text{ V to } 1.3 \text{ V}$	-	0.5	-	1.4	-	1.4	-	ns
		$V_{CC} = 1.4 \text{ V to } 1.6 \text{ V}$	-	0.3	-	1.0	-	1.0	-	ns
		V_{CC} = 1.65 V to 1.95 V	-	0.3	-	0.9	-	0.9	-	ns
		$V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$	-	0.3	-	0.7	-	0.7	-	ns
		$V_{CC} = 3.0 \text{ V to } 3.6 \text{ V}$	-	0.2	-	0.6	-	0.6	-	ns
t _{su(L)}	set-up time	D to CP; see Figure 7								
	LOW	V _{CC} = 0.8 V	-	3.5	-	-	-	-	-	ns
		$V_{CC} = 1.1 \text{ V to } 1.3 \text{ V}$	-	0.8	-	1.8	-	1.8	-	ns
		$V_{CC} = 1.4 \text{ V to } 1.6 \text{ V}$	-	0.6	-	1.2	-	1.2	-	ns
		$V_{CC} = 1.65 \text{ V to } 1.95 \text{ V}$	-	0.5	-	1.1	-	1.1	-	ns
		$V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$	-	0.4	-	1.0	-	1.0	-	ns
		$V_{CC} = 3.0 \text{ V to } 3.6 \text{ V}$		0.5		1.0		1.0		

Low-power D-type flip-flop; positive-edge trigger; 3-state

 Table 8.
 Dynamic characteristics ...continued

Voltages are referenced to GND (ground = 0 V); for test circuit see Figure 9.

Symbol	Parameter	Conditions		25 °C		-40 °C to +125 °C				Unit
			Min	Typ[1]	Max	Min (85 °C)	Max (85 °C)	Min (125 °C)	Max (125 °C)	
t _h	hold time	D to CP; see Figure 7	'			'		'		•
		V _{CC} = 0.8 V	-	-2.8	-	-	-	-	-	ns
		V _{CC} = 1.1 V to 1.3 V	-	-0.7	-	0	-	0	-	ns
		$V_{CC} = 1.4 \text{ V to } 1.6 \text{ V}$	-	-0.4	-	0	-	0	-	ns
		$V_{CC} = 1.65 \text{ V to } 1.95 \text{ V}$	-	-0.4	-	0	-	0	-	ns
		$V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$	-	-0.3	-	0	-	0	-	ns
		$V_{CC} = 3.0 \text{ V to } 3.6 \text{ V}$	-	-0.4	-	0	-	0	-	ns
C _{PD}	power dissipation capacitance	$V_I = GND \text{ to } V_{CC};$	<u>[5]</u>							
		f _i = 1 MHz; output enabled								
		V _{CC} = 0.8 V	-	1.7	-	-	-	-	-	pF
		$V_{CC} = 1.1 \text{ V to } 1.3 \text{ V}$	-	1.8	-	-	-	-	-	pF
		$V_{CC} = 1.4 \text{ V to } 1.6 \text{ V}$	-	1.8	-	-	-	-	-	pF
		$V_{CC} = 1.65 \text{ V to } 1.95 \text{ V}$	-	2.0	-	-	-	-	-	pF
		$V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$	-	2.3	-	-	-	-	-	pF
		$V_{CC} = 3.0 \text{ V to } 3.6 \text{ V}$	-	2.8	-	-	-	-	-	pF

^[1] All typical values are measured at nominal V_{CC}.

[5] C_{PD} is used to determine the dynamic power dissipation (P_D in μW).

$$P_D = C_{PD} \times V_{CC}^2 \times f_i \times N + \Sigma (C_L \times V_{CC}^2 \times f_o) \text{ where:}$$

f_i = input frequency in MHz;

 f_o = output frequency in MHz;

C_L = output load capacitance in pF;

V_{CC} = supply voltage in V;

 $\Sigma(C_L \times V_{CC}^2 \times f_o)$ = sum of the outputs;

N = number of inputs switching.

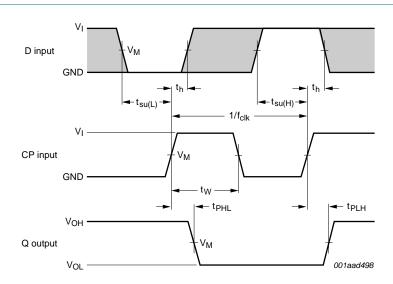
^[2] t_{pd} is the same as t_{PLH} and t_{PHL} .

^[3] t_{en} is the same as t_{PZH} and t_{PZL} .

^[4] t_{dis} is the same as t_{PHZ} and t_{PLZ} .

Low-power D-type flip-flop; positive-edge trigger; 3-state

12. Waveforms



Measurement points are given in Table 9.

The shaded areas indicate when the input is permitted to change for predictable output performance.

Logic levels: V_{OL} and V_{OH} are typical output voltage levels that occur with the output load.

Fig 7. The clock input (CP) to output (Q) propagation delays, clock input (CP) pulse width, data input (D) to clock input (CP) set-up times, clock input (CP) to data input (D) hold times and the maximum frequency (CP)

Table 9. Measurement points

Supply voltage	Input			Output			
V _{CC}	V _M	VI	$t_r = t_f$	V _M	V _X	V _Y	
0.8 V to 1.6 V	$0.5 \times V_{CC}$	V_{CC}	≤ 3.0 ns	$0.5 \times V_{CC}$	V _{OL} + 0.1 V	$V_{OH} - 0.1 V$	
1.65 V to 2.7 V	$0.5 \times V_{CC}$	V_{CC}	≤ 3.0 ns	$0.5 \times V_{CC}$	V _{OL} + 0.15 V	$V_{OH}-0.15\ V$	
3.0 V to 3.6 V	$0.5 \times V_{CC}$	V_{CC}	≤ 3.0 ns	$0.5 \times V_{CC}$	V_{OL} + 0.3 V	$V_{OH}-0.3\ V$	

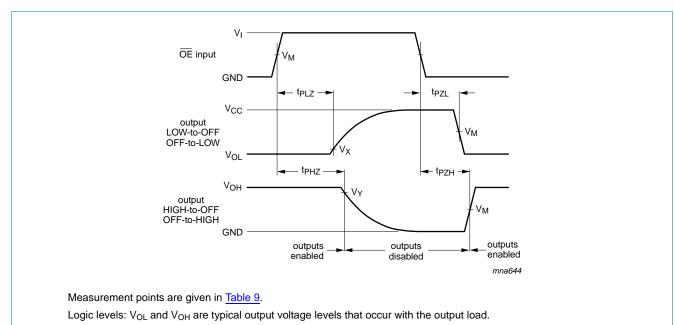
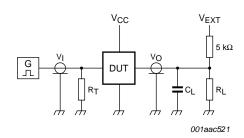


Fig 8. Enable and disable times



Test data is given in Table 10.

Definitions for test circuit:

 R_{I} = Load resistance.

C_L = Load capacitance including jig and probe capacitance.

 R_T = Termination resistance should be equal to the output impedance Z_0 of the pulse generator.

 V_{EXT} = External voltage for measuring switching times.

Fig 9. Test circuit for measuring switching times

Table 10. Test data

Supply voltage	Load		V _{EXT}			
V _{CC}	CL	R _L [1]	t _{PLH} , t _{PHL}	t _{PZH} , t _{PHZ}	t _{PZL} , t _{PLZ}	
0.8 V to 3.6 V	5 pF, 10 pF, 15 pF and 30 pF	5 k Ω or 1 M Ω	open	GND	$2\times V_{CC}$	

^[1] For measuring enable and disable times $R_L = 5 \text{ k}\Omega$, for measuring propagation delays, set-up and hold times and pulse width $R_L = 1 \text{ M}\Omega$.

13. Package outline

Plastic surface-mounted package; 6 leads

SOT363

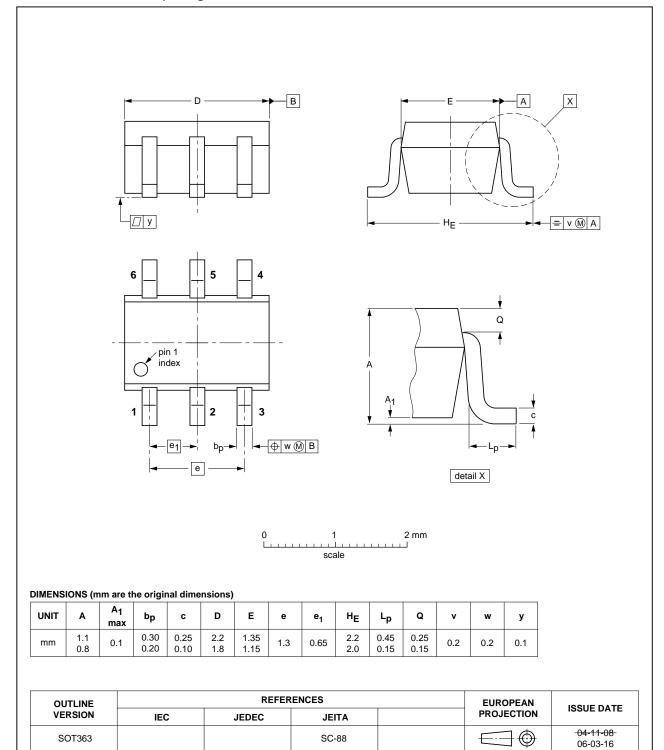


Fig 10. Package outline SOT363 (SC-88)

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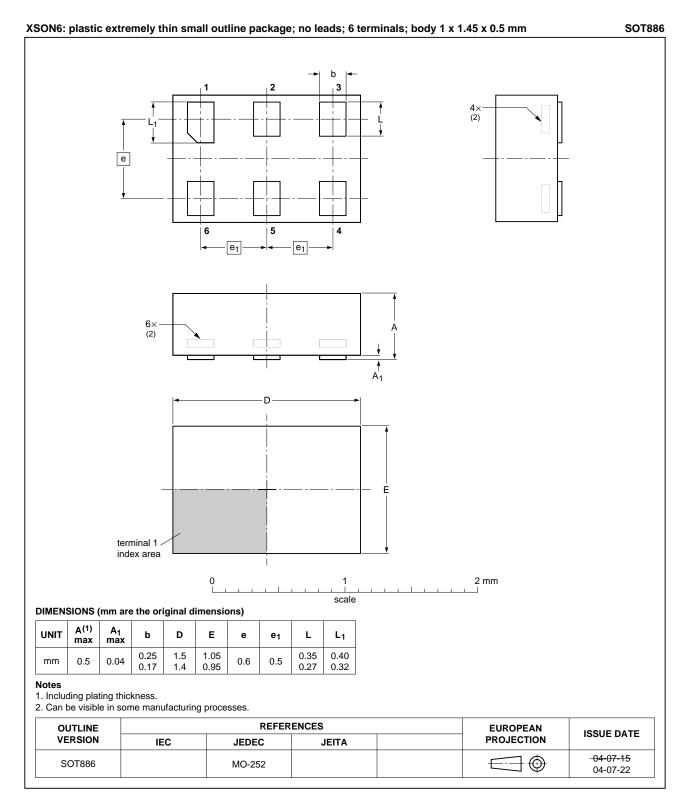


Fig 11. Package outline SOT886 (XSON6)

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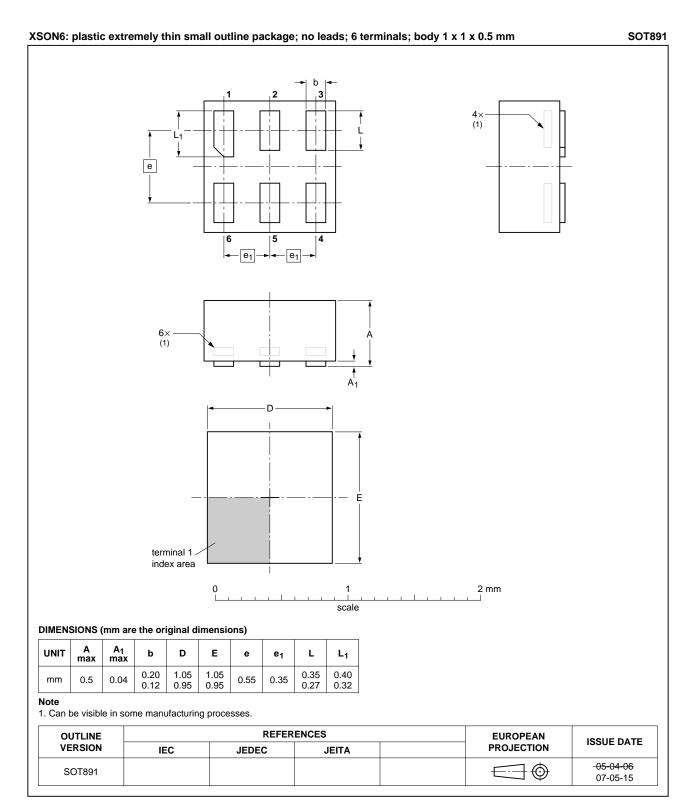


Fig 12. Package outline SOT891 (XSON6)

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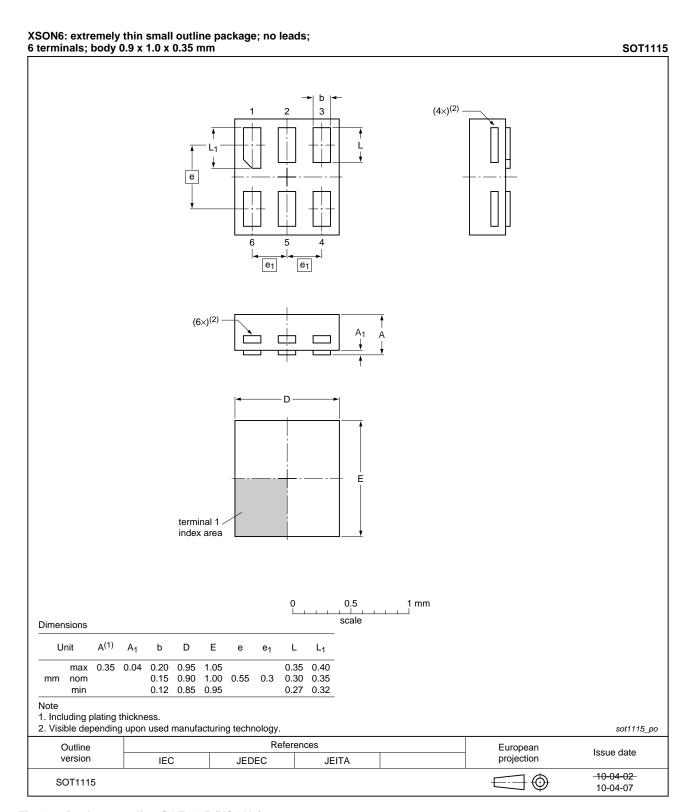


Fig 13. Package outline SOT1115 (XSON6)

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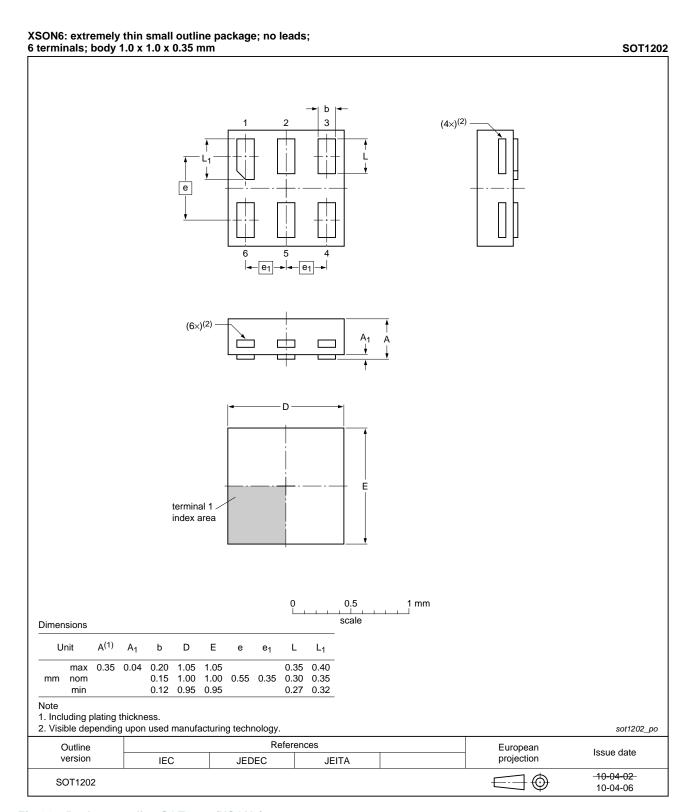


Fig 14. Package outline SOT1202 (XSON6)

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Low-power D-type flip-flop; positive-edge trigger; 3-state

14. Abbreviations

Table 11. Abbreviations

Acronym	Description
CDM	Charged Device Model
DUT	Device Under Test
ESD	ElectroStatic Discharge
HBM	Human Body Model
MM	Machine Model

15. Revision history

Table 12. Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes
74AUP1G374 v.5	20100714	Product data sheet	-	74AUP1G374 v.4
Modifications:	• •	number 74AUP1G374GN (So number 74AUP1G374GS (So		•
74AUP1G374 v.4	20090626	Product data sheet	-	74AUP1G374 v.3
74AUP1G374 v.3	20090414	Product data sheet	-	74AUP1G374 v.2
74AUP1G374 v.2	20080523	Product data sheet	-	74AUP1G374 v.1
74AUP1G374 v.1	20061114	Product data sheet	-	-

16. Legal information

16.1 Data sheet status

Document status[1][2]	Product status[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

- [1] Please consult the most recently issued document before initiating or completing a design.
- [2] The term 'short data sheet' is explained in section "Definitions"
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Low-power D-type flip-flop; positive-edge trigger; 3-state

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